TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

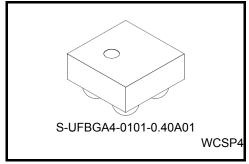
# TCR4S12DWBG~TCR4S36DWBG

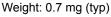
# 200 mA CMOS Low-Dropout Regulator

The TCR4S12DWBG to TCR4S36DWBG are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring low dropout voltage and low quiescent bias current. The TCR4S12WBG to TCR4S36WBG can be enabled and disabled via the CONTROL pin.

These voltage regulators are available in fixed output voltages between 1.2 V and 3.6 V in 0.05-V steps and capable of driving up to 200 mA. They feature overcurrent protection and auto-discharge.

The TCR4S12DWBG to TCR4S36DWBG are offered in the compact WCSP (0.79 mm x 0.79 mm x 0.50 mm) and allow the use of small ceramic input and output capacitors. Thus, these devices are ideal for portable applications that require high-density board assembly such as cellular phones.

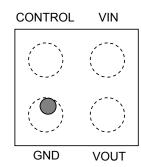




# Features

- Low quiescent bias current ( $I_B = 50 \ \mu A (typ.)$  at  $I_{OUT} = 0 \ mA$ )
- Low stand-by current (  $I_{B(OFF)}$  = 0.1  $\mu$ A (typ.) at Stand-by mode )
- Low dropout voltage (V<sub>IN</sub> V<sub>OUT</sub> = 90 mV (typ.) at TCR4S25DWBG, I<sub>OUT</sub> = 50 mA)
- High ripple rejection ratio (R.R = 80 dB (typ) at I<sub>OUT</sub> = 10 mA, f =1kHz)
- Low output noise voltage (V<sub>NO</sub> = 30  $\mu$ V<sub>rms</sub> (typ.) at TCR4S25DWBG, I<sub>OUT</sub> = 10 mA, 10 Hz  $\leq$  f  $\leq$  100 kHz)
- Auto-discharge
- Control pull-down resistor
- Overcurrent protection
- Ceramic capacitors can be used (  $C_{IN}$  = 0.1  $\mu$ F,  $C_{OUT}$  =1.0  $\mu$ F )
- Very small package, WCSP ( 0.79 mm x 0.79 mm x 0.50 mm )

### Pin Assignment (top view)

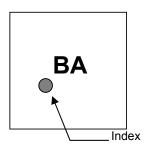


## List of Products Number and Marking

Products No.	Marking	Products No.	Marking	
TCR4S12DWBG	В3	TCR4S26DWBG	BN	
TCR4S13DWBG	B4	TCR4S27DWBG	BO	
TCR4S14DWBG	В5	TCR4S28DWBG	BP	
TCR4S15DWBG	BA	TCR4S285DWBG	В7	
TCR4S16DWBG	BB	TCR4S29DWBG	BR	
TCR4S17DWBG	BD	TCR4S295DWBG	B6	
TCR4S18DWBG	BE	TCR4S30DWBG	BS	
TCR4S19DWBG	BF	TCR4S31DWBG	ВТ	
TCR4S20DWBG	BG	TCR4S32DWBG	BV	
TCR4S21DWBG	ВН	TCR4S33DWBG	BW	
TCR4S22DWBG	BI	TCR4S34DWBG	BX	
TCR4S23DWBG	ВК	TCR4S35DWBG	BY	
TCR4S24DWBG	BL	TCR4S36DWBG	BZ	
TCR4S25DWBG	BM			

### Marking (top view)

Example: TCR4S15DWBG (1.5 V output)



# Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Input voltage	V <sub>IN</sub>	6 (Note 1)	V
Control voltage	V <sub>CT</sub>	-0.3 to V <sub>IN</sub>	V
Output voltage	V <sub>OUT</sub>	-0.3 to V <sub>IN</sub> + 0.3	V
Output current	IOUT	200	mA
Power dissipation	PD	800 (Note 2)	mW
Operation temperature range	T <sub>opr</sub>	-40 to 85	°C
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	–55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1):  $V_{IN}$  for 1.2 V to 1.4V output product is 5.5 V.

(Note 2): Rating at mounting on a board (Glass epoxy board dimension: 40mm x 40mm, both sides of board Wireability: a surface approximately 50%, the reverse side approximately 50% Through hole hall: diameter 0.5mm x 28)

#### Electrical Characteristics (Unless otherwise specified, $V_{IN} = V_{OUT} + 1 V$ , $I_{OUT} = 50 \text{ mA}$ , $C_{IN} = 0.1 \mu\text{F}$ , $C_{OUT} = 1.0 \mu\text{F}$ , $T_j = 25^{\circ}\text{C}$ )(Note 3)

Characteristics	Symbol	Test	Min	Тур.	Max	Unit	
Output voltage	V <sub>OUT</sub>	Please refer to the Output Voltage Accuracy table				1	
Line regulation	Reg·line	$V_{OUT}$ + 0.5 V $\leq$ V <sub>IN</sub> $\leq$ 6 V, I <sub>OUT</sub> = 1 mA (Note 4)		_	1	15	mV
Load regulation	Reg·load	$1 \text{ mA} \leq I_{OUT} \leq 150 \text{ mA}$	A	—	5	30	mV
Quiescent current	Ι <sub>Β</sub>	I <sub>OUT</sub> = 0 mA		—	50	75	μA
Stand-by current	I <sub>B (OFF)</sub>	$V_{CT} = 0 V$			0.1	1.0	μA
Dropout voltage	VIN-VOUT		Please refer to the Drop	out voltage	table		
Temperature coefficient	T <sub>CVO</sub>	$-40^\circ C \leq T_{opr} \leq 85^\circ C$		—	100		ppm/°C
Output noise voltage			TCR4S12DWBG to TCR4S20DWBG	—	25	—	
	V <sub>NO</sub>	$V_{IN} = V_{OUT} + 1 V,$ $I_{OUT} = 10 \text{ mA},$ $10 \text{ Hz} \le f \le 100 \text{ kHz},$ $Ta = 25^{\circ}\text{C}$	TCR4S21DWBG to TCR4S30DWBG	_	30	_	μV <sub>rms</sub>
			TCR4S31DWBG to TCR4S36DWBG	_	35		
			TCR4S12DWBG	1.8		5.5	
Input voltage			TCR4S13DWBG to TCR4S14DWBG	1.85	_	5.5	
			TCR4S15DWBG to TCR4S19DWBG	V <sub>OUT</sub> + 0.35 V		6.0	
	V <sub>IN</sub>		TCR4S20DWBG to TCR4S21DWBG	V <sub>OUT</sub> + 0.28 V		6.0 6.0	V
			TCR4S22DWBG to TCR4S24DWBG	V <sub>OUT</sub> + 0.25 V	_		
			TCR4S25DWBG to TCR4S36DWBG	V <sub>OUT</sub> + 0.20 V		6.0	
Ripple rejection ratio	R.R.	$\label{eq:VIN} \begin{split} V_{IN} &= V_{OUT} + 1 \ V, \ I_{OUT} = 10 \ mA, \\ f &= 1 \ kHz, \ V_{Ripple} = 500 \ mV_{p-p}, \\ Ta &= 25^{\circ}C \end{split}$		_	80	_	dB
Control voltage (ON)	V <sub>CT (ON)</sub>	(Note 5)		1.1	—	6.0	V
Control voltage (OFF)	V <sub>CT (OFF)</sub>		0		0.4	V	

Note 3: Unless otherwise specified, V\_{IN} for 1.2V to 1.4V output product is V\_{OUT.} + 0.5 V

Note 4: V\_{IN} for 1.2V to 1.4V output product is V\_{OUT} + 0.5 V  $\leq$  V\_{IN}  $\leq$  5.5 V

Note 5:  $V_{CT (ON)}$  of 1.2V to 1.4V output product is 5.5V (max)

Output Voltage Accuracy (V<sub>IN</sub> = V<sub>OUT</sub> + 1 V, I<sub>OUT</sub> = 50 mA, C<sub>IN</sub> = 0.1  $\mu$ F, C<sub>OUT</sub> = 1.0  $\mu$ F, T<sub>j</sub> = 25°C)

Dreduct No.	Currente e l	Min	Ture	Max	L Insit
Product No.	Symbol	Min	Тур.	Max	Unit
TCR4S12DWBG		1.17	1.2	1.23	
TCR4S13DWBG		1.27	1.3	1.33	
TCR4S14DWBG		1.37	1.4	1.43	
TCR4S15DWBG		1.47	1.5	1.53	
TCR4S16DWBG		1.56	1.6	1.64	
TCR4S17DWBG		1.66	1.7	1.74	
TCR4S18DWBG		1.76	1.8	1.84	
TCR4S19DWBG		1.86	1.9	1.94	
TCR4S20DWBG		1.96	2.0	2.04	
TCR4S21DWBG		2.05	2.1	2.15	
TCR4S22DWBG		2.15	2.2	2.25	
TCR4S23DWBG		2.25	2.3	2.35	
TCR4S24DWBG		2.35	2.4	2.45	
TCR4S25DWBG	V <sub>OUT</sub>	2.45	2.5	2.55	V
TCR4S26DWBG		2.54	2.6	2.66	
TCR4S27DWBG		2.64	2.7	2.76	
TCR4S28DWBG		2.74	2.8	2.86	
TCR4S285DWBG		2.79	2.85	2.91	
TCR4S29DWBG		2.84	2.9	2.96	
TCR4S295DWBG		2.89	2.95	3.01	
TCR4S30DWBG		2.94	3.0	3.06	
TCR4S31DWBG		3.03	3.1	3.17	
TCR4S32DWBG		3.13	3.2	3.27	
TCR4S33DWBG		3.23	3.3	3.37	
TCR4S34DWBG		3.33	3.4	3.47	
TCR4S35DWBG		3.43	3.5	3.57	
TCR4S36DWBG		3.52	3.6	3.68	

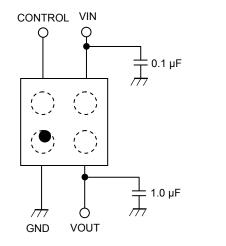
# Dropout Voltage (I\_OUT = 50 mA, C\_IN = 0.1 $\mu\text{F},$ C\_OUT = 1.0 $\mu\text{F},$ T\_j = 25°C)

Product No.	Symbol	Min	Тур.	Max	Unit
TCR4S12DWBG		—	400	600	
TCR4S13DWBG		_	350	550	
TCR4S14DWBG		_	300	450	
TCR4S15DWBG to TCR4S19DWBG			200	350	
TCR4S20DWBG to TCR4S21DWBG	VIN-VOUT		150	280	mV
TCR4S22DWBG to TCR4S24DWBG			130	250	
TCR4S25DWBG to TCR4S36DWBG		—	90	200	

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# **Application Note**

## 1. Recommended Application (top view)



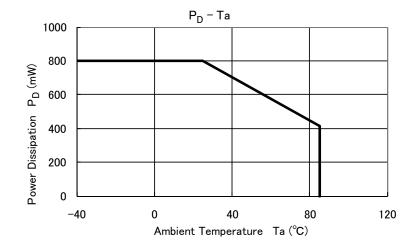
Control Level	Operation
HIGH	ON
LOW	OFF

The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor to  $V_{\text{OUT}}$  and  $V_{\text{IN}}$  for stable input/output operation. (ceramic capacitors can be used)

### 2. Power Dissipation

Power dissipation is measured on the board condition shown below.

[The Board Condition] Board material: Glass epoxy Board dimension: 40 mm x 40 mm , both sides of board , t=1.8 mm Wireability: a surface approximately 50% the reverse side approximately 50% Through hole hall: diameter 0.5 mm x 28



# Attention in Use

#### Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under  $10 \Omega$ .

#### Mounting

The long distance between IC and output capacitor might affect phase assurance by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also GND pattern need to be large and make the wire impedance small as possible.

#### Permissible Loss

Please have enough board design patterns for expected maximum permissible loss. And under consideration of surrounding temperature, input voltage, and output current etc, please apply proper dissipation ratings for maximum permissible loss.

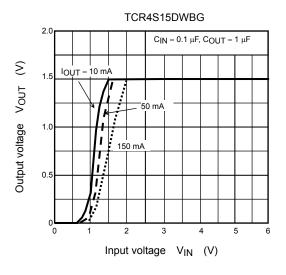
#### • Overcurrent Protection Circuit

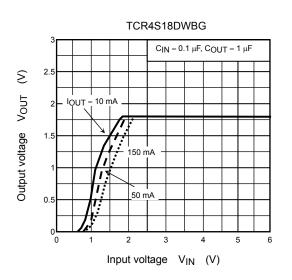
Overcurrent protection circuit is designed in these products, but this does not assure for the suppression of uprising device operation. If output pins and GND pins are shorted out, these products might be break down.

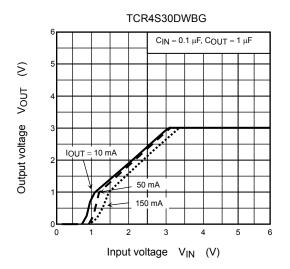
In use of these products, please read through and understand dissipation idea for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommend inserting failsafe system into the design.

### **Representative Typical Characteristics**

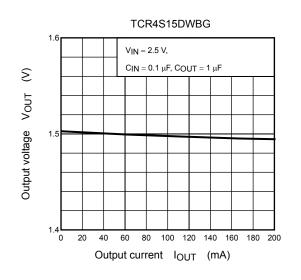
1) Output Voltage vs. Input Voltage

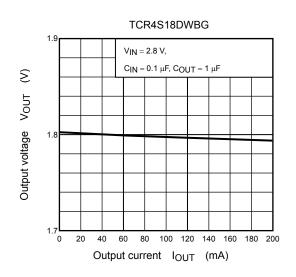


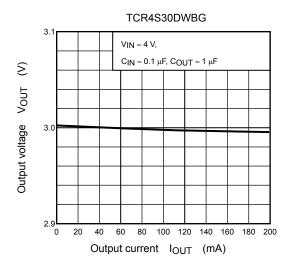




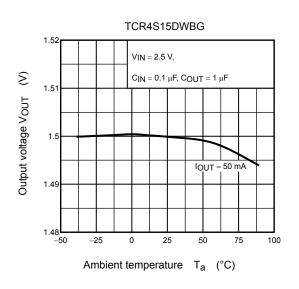
2) Output Voltage vs. Output Current

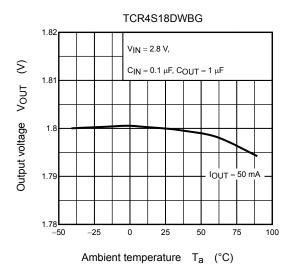


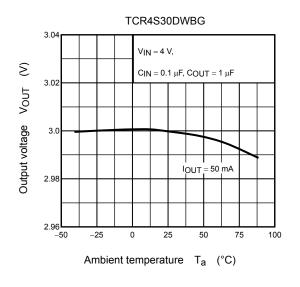




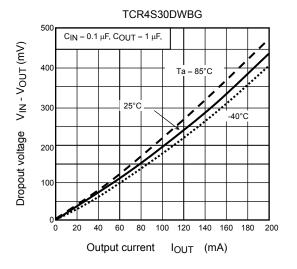
3) Output Voltage vs. Ambient temperature



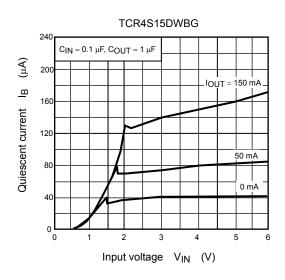


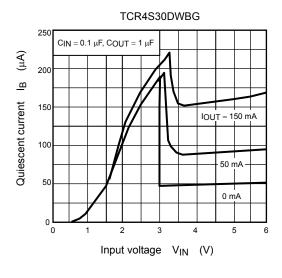


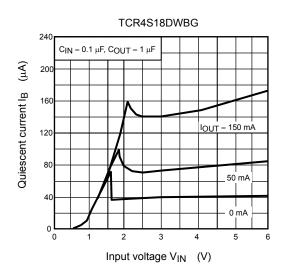
4) Dropout Voltage vs. Output Current



#### 5) Quiescent Current vs. Input Voltage

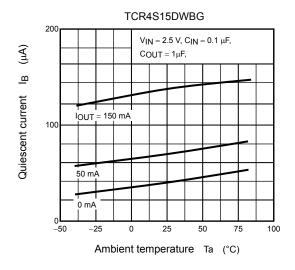


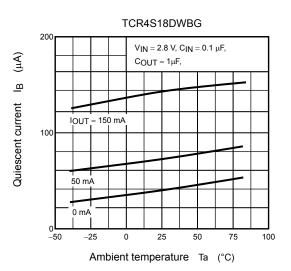


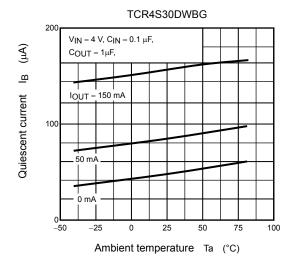


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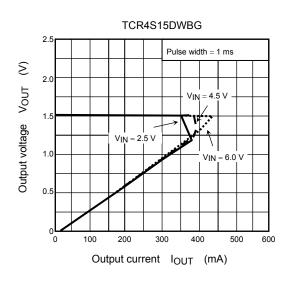
#### 6) Quiescent current vs. Ambient temperature

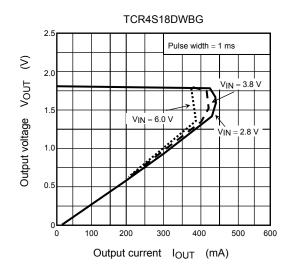


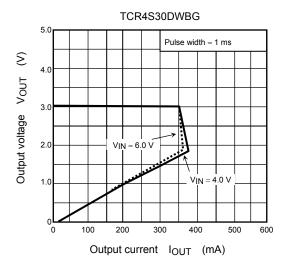




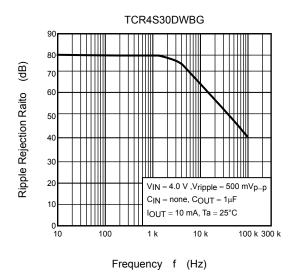
7) Overcurrent Protection Characteristics



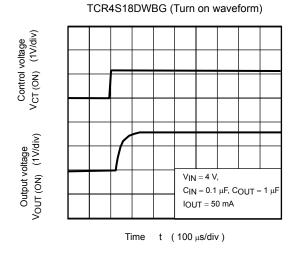


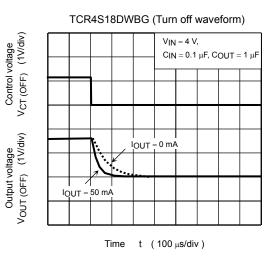


8) Ripple rejection Raito vs. Frequency

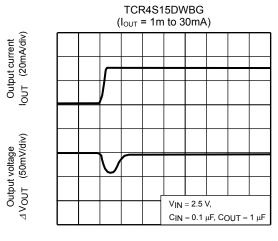


#### 9) Control Transient Response (Auto-Discharge)

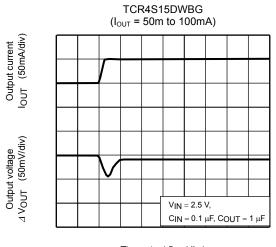




#### 10) Load Transient Response

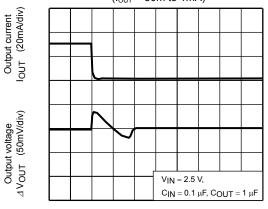


Time t ( 5  $\mu\text{s/div}$  )

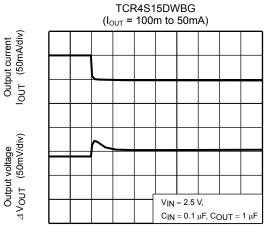


Time t (5 µs/div)

TCR4S15DWBG (I<sub>OUT</sub> = 30m to 1mA)

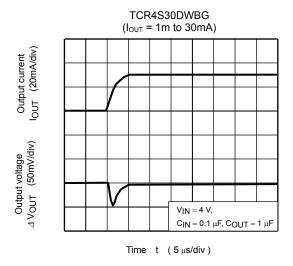


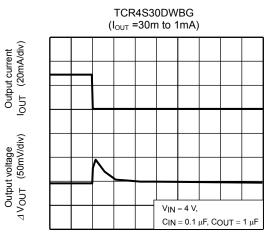
Time t ( 20  $\mu s/div$  )



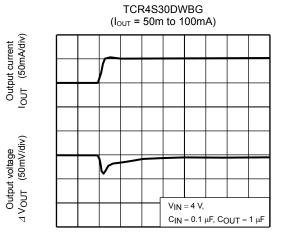
Time t ( 20  $\mu s/div$  )

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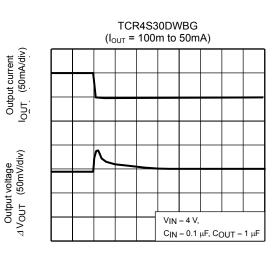




Time t (20 µs/div)



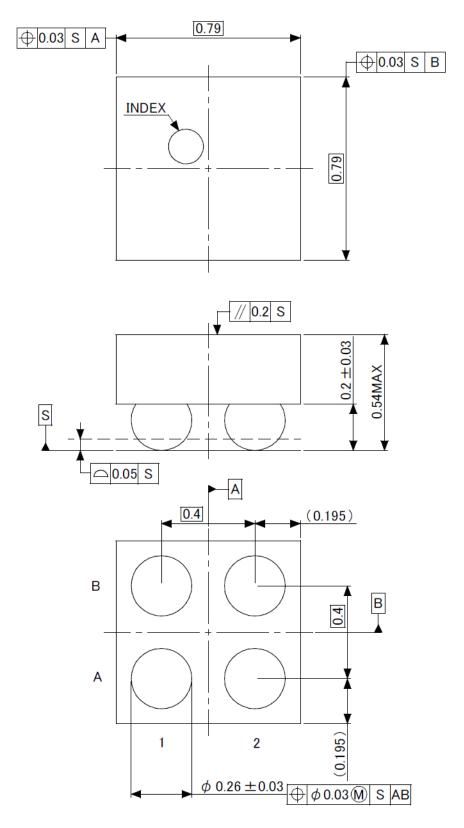
Time t (5 µs/div)



Time t (20 µs/div)

# **Package Dimensions**

Unit: mm



Weight: 0.7 mg (typ)

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